

Preface

These proceedings contain papers selected for presentation at the 5th International Symposium on Security in Computing and Communications (SSCC 2017). SSCC aims to provide an opportunity to bring together researchers and practitioners from both academia and industry to exchange knowledge and discuss research findings. The symposium was held in Manipal Institute of Technology, Manipal University, Karnataka, India, during September 13–16, 2017. SSCC 2017 was co-located with the International Conference on Applied Soft Computing and Communication Networks (ACN 2017).

In response to the call for papers 84 papers were submitted to the symposium. These papers were evaluated on the basis of their significance, novelty, and technical quality. A double-blind review process was conducted to ensure that the author names and affiliations were unknown to the Technical Program Committee (TPC). Each paper was reviewed by the members of the TPC and finally, 21 regular papers and 13 short papers were selected for presentation at the symposium (acceptance ratio: $\sim 40\%$).

The organization of the symposium benefited from the efforts of many individuals. We would like to thank the TPC members and external reviewers for their timely expertise in carefully reviewing the submissions. We would like to thank the general chair and members of the Advisory Committee for their support. We express our most sincere thanks to all keynote speakers who shared with us their expertise and knowledge.

Special thanks to members of the Organizing Committee for their time and effort in organizing the symposium. We wish to thank all the authors who submitted papers and all participants and contributors to fruitful discussions. Finally, we would like to acknowledge Springer for the active cooperation and timely production of the proceedings.

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